



### High-Speed I3C 1:2 Multiplexer/DeMultiplexer Switch with Signal Enable

### Description

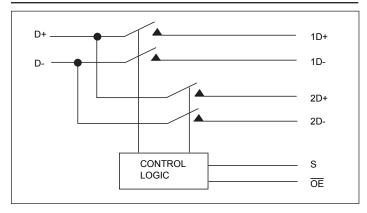
The PI3CSW12 is a high-bandwidth switch specially designed for the switching of high-speed I3C signals in communication and server applications, such as servers, workstations, and notebooks with hubs or controllers with limited I3C I/Os. The wide bandwidth (1.6GHz) of this switch allows signals to pass with minimum edge and phase distortion.

The device multiplexes differential outputs from a I3C host device to one of two corresponding outputs. The switch is bidirectional and offers little or no attenuation of the high-speed signals at the outputs. It is designed for low bit-to-bit skew and high channel-tochannel noise isolation, and is compatible with various standards, such as high-speed I3C (up to 30Mbps).

### Application(s)

- Routing I3C Signals
- Routing Mobile Industry Processor Interface (MIPI) Signals

### **Block Diagram**



### **Truth Table**

S	<del>OE</del>	Function	
X	Н	Disconnect	
L	L	D = 1D	
Н	L	D = 2D	

#### **Features**

- V<sub>DD</sub> Operation at 2.5V and 3.3V
- V<sub>I/O</sub> Accepts Signals Up to 5.5V
- 1.8V Compatible Control-Pin Inputs
- Low-Power Mode When  $\overline{OE}$  Is Disabled (2µA)
- $r_{ON} = 6\Omega$  Maximum
- $\Delta r_{ON} = 0.2\Omega$  Typical
- Cio(on) = 4pF Typical
- Supports Over Voltage Protection
- Low Power Consumption (50µA Maximum)
- **ESD Performance** 
  - IO Pins
  - 12KV HBM
  - 1KV CDM
  - +/-8KV Contact Discharge (IEC61000-4-2)
  - VDD, GND, S, OE Pins
  - 4KV HBM
  - □ 1KV CDM
- High Bandwidth (1.6GHz Typical)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

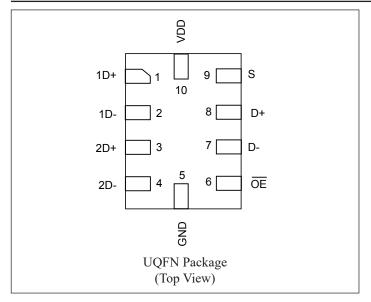
- Packaging (Pb-free & Green):
  - □ 10-contact, UQFN (ZUA)

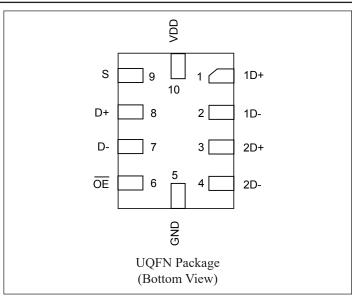
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.





# **Pin Configuration**





# **Pin Description**

Name	Description
ŌĒ	Active LOW, Output enable
S	Select input
D	COM port
nD	I/O for I3C data path (port 1 and port 2)





## Absolute Maximum Ratings(1)

Over operating free-air temperature range (unless otherwise noted)

1 0 1	,
V <sub>DD</sub> Supply Voltage Range	
V <sub>IN</sub> Control Input Voltage Range <sup>(2, 3)</sup>	0.5V to 5.5V
V <sub>I/O</sub> Switch I/O Voltage Range <sup>(2, 3, 4)</sup>	0.5V to 5.5V
I <sub>IK</sub> Control Input Clamp Current (V <sub>IN</sub> < 0)	50mA
I <sub>I/OK</sub> I/O Port Clamp Current (V <sub>I/O</sub> < 0)	
I <sub>I/O</sub> ON-state Switch Current <sup>(5)</sup>	±120mA
Continuous Current through V <sub>DD</sub> or GND	±100mA
$\theta_{ m JA}$ Package Thermal Impedance	
TLLGA Package	48.7°C/W
TDFN Package	243°C/W
T <sub>stg</sub> Storage Temperature Range	65 to 150°C
Tj Junction Temperature	125°C

#### Notes:

- Stresses beyond those listed under "absolute maximum ratings"
  may cause permanent damage to the device. These are stress ratings
  only, and functional operation of the device at these or any other
  conditions beyond those indicated under "recommended operating
  conditions" is not implied. Exposure to absolute-maximum-rated
  conditions for extended periods may affect device reliability.
- 2. All voltages are with respect to ground, unless otherwise specified.
- 3. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 4. VI and VO are used to denote specific conditions for VI/O.
- 5. II and IO are used to denote specific conditions for II/O.
- The package thermal impedance is calculated in accordance with JESD 51-7.

# Recommended Operating Conditions(1)

Symbol	Description	Parameter	Min.	Max.	Unit
$V_{\mathrm{DD}}$	Supply voltage		2.3	3.6	
17	II:-l- 1141:14	$V_{\rm DD} = 2.3 \text{V to } 2.7 \text{V}$	1.3		
$V_{IH}$	High-level control input voltage	$V_{\rm DD} = 2.7 \text{V to } 3.6 \text{V}$	1.4		V
	T 1141414	$V_{\rm DD} = 2.3 \text{V to } 2.7 \text{V}$		0.6	V
V <sub>IL</sub> Low-level control input voltage		$V_{\rm DD} = 2.7 \text{V to } 3.6 \text{V}$		0.6	
V <sub>I/O</sub>	Data input/output voltage		0	4.6	
$T_{A}$	Operating free-air temperature		-40	85	°C

#### Note:

### **Electrical Characteristics**

Over operating free-air temperature range (unless otherwise noted)

Param	eter	Testing Conditions		Min.	Тур.	Max.	Unit
$V_{IK}$		$V_{\rm DD} = 3.6 \text{V}, 2.7 \text{V}, I_{\rm I} = -18 \text{mA}$				-1.2	V
$I_{IN}$	Control Inputs	$V_{\rm DD} = 3.6 \text{V}, 2.7 \text{V}, 0 \text{V}, V_{\rm IN} = 0 \text{V} \text{ to } 3.6 \text{V}$				±1	μΑ
$I_{OZ}^{(3)}$		$V_{\rm DD}$ = 3.6V, 2.7V, $V_{\rm IN}$ = $V_{\rm DD}$ or GND, $V_{\rm O}$ = 0V to 3.6V, $V_{\rm I}$ = 0V, Switch OFF				±1	μΑ
I <sub>(OFF)</sub>		N. ON	$V_{I/O} = 0V$ to 3.6V			±2	μΑ
		$V_{DD} = 0V$ $V_{I/O} = 0V \text{ to } 2.7V$				±1	μΑ
$I_{CC}$	$V_{\mathrm{DD}}$ = 3.6V, 2.7V, $V_{\mathrm{IN}}$ = $V_{\mathrm{DD}}$ or GND, $I_{\mathrm{I/O}}$ = 0V, Switch ON or OFF			25	50	μΑ	
$I_{CC}$ (low power MDD = 3.6V, 2.7V, $V_{IN} = V_{DD}$ or GND, Switch disabled, ( $\overline{OE}$ in high state)				4	μΑ		

<sup>1.</sup> All unused control inputs of the device must be held at V<sub>DD</sub> or GND to ensure proper device operation.





Parameter Testing Conditions		<b>Testing Conditions</b>		Min.	Тур.	Max.	Unit	
Control		$V_{\rm DD}$ = 2.7V, S sweeps from 1.4V	V to 3.3V, OE/ = 0V			15	μΑ	
DI <sub>CC</sub> <sup>(4)</sup>	Inputs	$V_{\rm DD}$ = 2.7V, OE/ sweeps from 1	.4V  to  3.3V, S = 0V			0.75	μΑ	
C <sub>IN</sub>	Control Inputs	$V_{\rm DD}$ = 3.3V, 2.5V, $V_{\rm IN}$ = 3.3V o	$V_{\rm DD} = 3.3 \text{V}, 2.5 \text{V}, V_{\rm IN} = 3.3 \text{V or } 0 \text{V}$			2	pF	
C <sub>io(OFF)</sub>	)	$V_{\rm DD}$ = 3.3V, 2.5V, $V_{\rm IN}$ = 3.3V or 0V, Switch OFF			2	3	pF	
C <sub>io(ON)</sub>		$V_{\rm DD}$ = 3.3V, 2.5V, $V_{\rm IN}$ = 3.3V or 0V, Switch ON			4		pF	
(5)		17 217 2 217	$V_{\rm I} = 0 \text{V},  I_{\rm O} = 30 \text{mA}$			4		
$r_{ON}^{(5)}$		$V_{DD} = 3V, 2.3V$	$V_{\rm I} = 2.4 \text{V}, I_{\rm O} = -15 \text{mA}$			6	Ω	
D (6)		V	$V_{\rm I} = 0$ V, $I_{\rm O} = 30$ mA		0.2		0	
$\mathrm{Dr_{ON}}^{(6)}$		$V_{DD} = 3V, 2.3V$	$V_{\rm I} = 1.7 \text{V}, I_{\rm O} = -15 \text{mA}$		0.2		Ω	
r <sub>ON(flat)</sub>		V. 01/ 0 01/	$V_{\rm I} = 0 \text{V}, I_{\rm O} = 30 \text{mA}$		1			
		$V_{DD} = 3V, 2.3V$	$V_{\rm I} = 1.7 \text{V}, I_{\rm O} = -15 \text{mA}$		1		Ω	
V <sub>pass</sub>		$V_{\rm DD} = 2.5 - 3.3 \text{V}$	$V_{IN} > 3.8V$ , $I_O = 10uA$	2.8	3.8	4.2	V	

### Notes:

- 1.  $V_{IN}$  and  $I_{IN}$  refer to control inputs. VI, VO, II, and IO refer to data pins.
- 2. All typical values are at  $V_{DD} = 3.3 \text{ V}$  (unless otherwise noted),  $T_A = 25^{\circ}\text{C}$ .
- 3. For I/O ports, the parameter IOZ includes the input leakage current.
- 4. This is the increase in supply current for each input that is at the specified TTL voltage level, rather than VDD or GND.
- 5. Measured by the voltage drop between the input and output terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two terminals.
- 6. Dron is delta Ron between channels

### **Dynamic Electrical Characteristics**

Over operating range,  $T_A = -40$ °C to 85°C,  $V_{DD} = 3.3 \text{ V} \pm 10\%$ , GND = 0 V

Symbol	Parameter	<b>Test Conditions</b>	Typ. (1)	Unit
V	C	$R_L = 50\Omega, f = 250MHz$	-40	
$X_{TALK}$	Crosstalk	$R_L = 50\Omega, f = 50MHz$	-55	dB
O <sub>IRR</sub>	OFF isolation	$R_L = 50\Omega, f = 250MHz$	-41	
BW	Bandwidth (-3 dB)	$R_L = 50\Omega$	1.6	GHz

#### Note:

1. For Max or Min conditions, use the appropriate value specified under Electrical Characteristics for the applicable device type.

# **Switching Characteristics**

Over operating range,  $T_A = -40^{\circ}\text{C}$  to 85°C,  $V_{DD} = 3.3 \text{ V} \pm 10\%$ , GND = 0V

Symbol	Parameter		Min.	Typ.(1)	Max.	Unit
$t_{pd}$	Propagation Delay (2,3)			0.25		ns
		S to D, nD			125	
$t_{ON}$	Line enable time	OE to D, nD			100	ns





Symbol	Parameter	Parameter		Typ.(1)	Max.	Unit
t I inc disable time		S to D, nD			12	
toff	Line disable time	OE to D, nD			12	ns
t <sub>SK(O)</sub>	Output skew between center pe	Output skew between center port to any other port(2)		0.1	0.2	ns
t <sub>SK(P)</sub>	Skew between opposite transiti	Skew between opposite transitions of the same output (tPHL – tPLH)		0.1	0.2	ns
t <sub>VPASS</sub>	OVP response time			53		ns

#### Notes:

- 1. For Max or Min conditions, use the appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Specified by design
- 3. The switch contributes no propagation delay other than the RC delay of the on resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25 ns for 10-pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interactions with the load on the driven side.





# **Application Information**

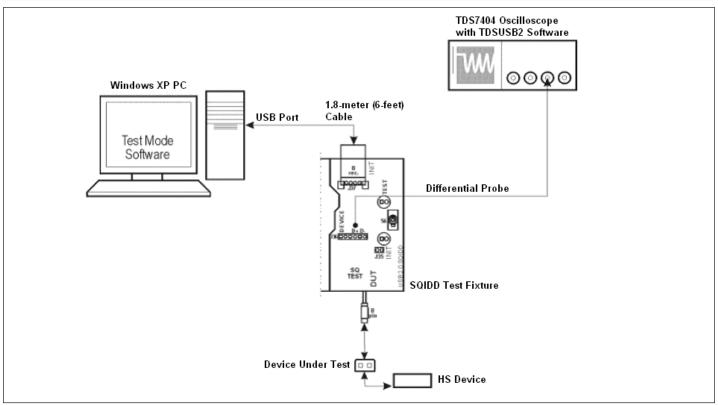


Figure 1. HS Eye Test Setup





### **Parameter Measurement Information**

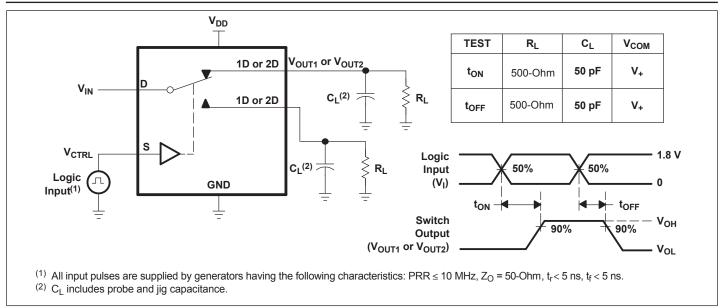


Figure 2. Turn-On (t<sub>ON</sub>) and Turn-Off Time (t<sub>OFF</sub>)

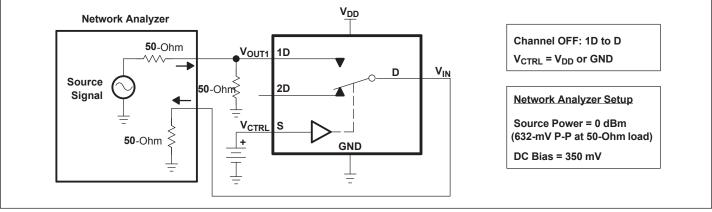


Figure 3. OFF Isolation (O<sub>ISO</sub>)

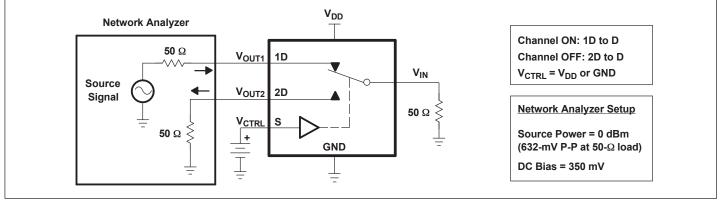


Figure 4. Crosstalk (X<sub>TALK</sub>)





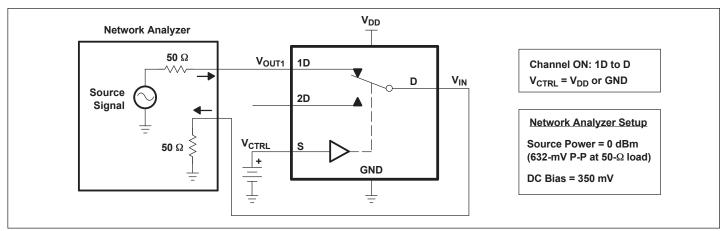


Figure 5. Bandwidth (BW)

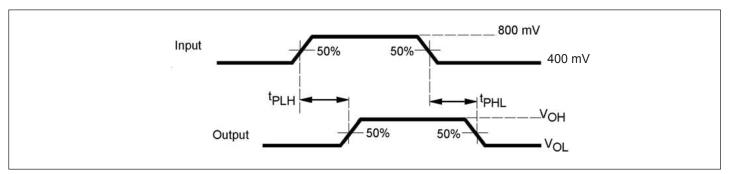


Figure 6. Propagation Delay



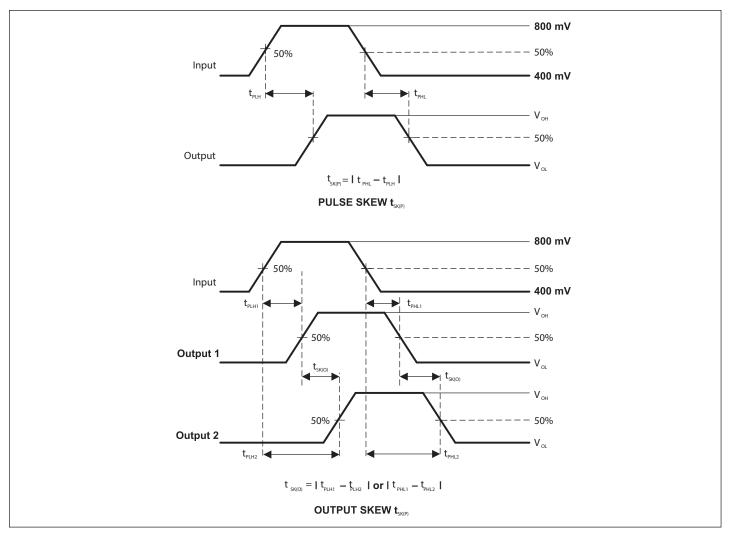


Figure 7. Skew Test

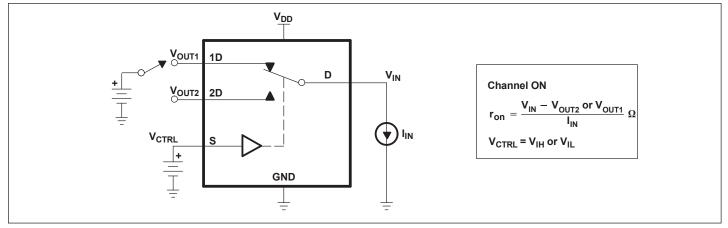


Figure 8. ON-State Resistance (ron)





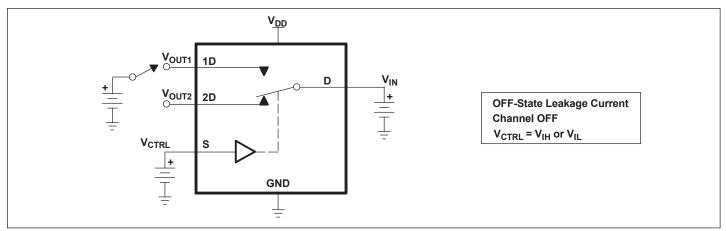


Figure 9. OFF-State Leakage Current

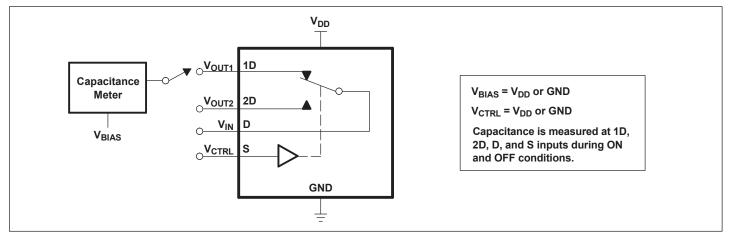


Figure 10. Capacitance





# **Part Marking**

▼ XM YW

xM: PI3CSW12ZUAE Y: Date Code (Year) W: Date Code (Workweek)

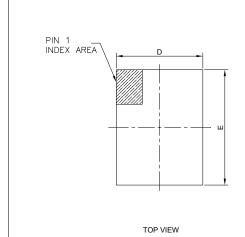
Bar above "X" denotes Pb-free and green

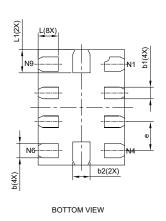


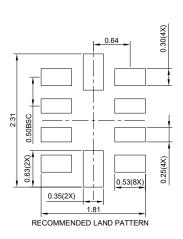


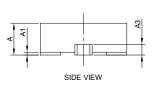
# **Packaging Mechanical**

### 10-UQFN (ZUA)









PKG DIMENSIONS					
SYMBOL	MIM	NOM	MAX		
Α	0.50		0.65		
A1	0.00	0.02	0.05		
A3		0.15 REF			
D	1.45	1.50	1.55		
Е	1.95	2.00	2.05		
b	0.20	0.25	0.30		
b1	0.15	0.20	0.25		
b2	0.25	0.30	0.35		
е	0.50 BSC				
L	0.25	0.35	0.45		
L1	0.30	0.40	0.50		

# PEDICOM STORES

DATE: 07/13/20

1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.

2. Ref: JEDEC MO-288B.
3. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.

I N C O N P O N A Y E D ENABLING SERIAL CONNECTIVITY	
DESCRIPTION: 10-Pin, UQFN, 1.5X2.0 (U-QFN1520-10)	
PACKAGE CODE: ZUA(ZUA10)	
DOCUMENT CONTROL#: PD-2220	REVISION: A

#### For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

# **Ordering Information**

Ordering Number	Package Code	Package Description	Pin 1 Orientation
PI3CSW12ZUAEX	ZUA	10-Pin, 1.5 x 2.0 (UQFN) (U-QFN 1520-10)	Top Left
PI3CSW12ZUAEX-7R	ZUA	10-Pin, 1.5 x 2.0 (UQFN) (U-QFN 1520-10)	Bottom Left

#### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. E = Pb-free and Green
- 5. X suffix = Tape/Reel





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